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<u>Texas Instruments</u> <u>SN74ALVCH16500DGGR</u>

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FEATURES

Distributor of Texas Instruments: Excellent Integrated System Limited

Datasheet of SN74ALVCH16500DGGR - IC UNIV BUS TXRX 18BIT 56TSSOP

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SN74ALVCH16500 18-BIT UNIVERSAL BUS TRANSCEIVER WITH 3-STATE OUTPUTS

SCES023I-JULY 1995-REVISED OCTOBER 2004

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EXAS

NSTRUMENTS

Member of the Texas Instruments Widebus™ Family

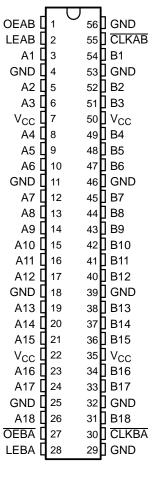
- EPIC™ (Enhanced-Performance Implanted CMOS) Submicron Process
- UBT[™] (Universal Bus Transceiver) Combines
 D-Type Latches and D-Type Flip-Flops for
 Operation in Transparent, Latched, or Clocked
 Modes
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Latch-UP Performance Exceeds 250 mA Per JESD 17
- Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors
- Package Options Include Plastic 300-mil Shrink Small-Outline (DL) and Thin Shrink Small-Outline (DGG) Packages

DESCRIPTION

This 18-bit universal bus transceiver is designed for 1.65-V to 3.6-V $V_{\rm CC}$ operation.

Data flow in each direction is controlled by output-enable (OEAB and OEBA), latch-enable (LEAB and LEBA), and clock (CLKAB and CLKBA) inputs. For A-to-B data flow, the device operates in the transparent mode when LEAB is high. When LEAB is low, the A data is latched if CLKAB is held at a high or low logic level. If LEAB is low, the A data is stored in the latch/flip-flop on the high-to-low transition of CLKAB. Output-enable OEAB is active high. When OEAB is low, the B-port outputs are in the high-impedance state.

DGG OR DL PACKAGE (TOP VIEW)



Data flow for B to A is similar to that of A to B, but uses $\overline{\text{OEBA}}$, LEBA, and $\overline{\text{CLKBA}}$. The output enables are complementary (OEAB is active high, and $\overline{\text{OEBA}}$ is active low).

To ensure the high-impedance state during power up or power down, $\overline{\text{OEBA}}$ should be tied to V_{CC} through a pullup resistor, and OEAB should be tied to GND through a pulldown resistor; the minimum value of the resistor is determined by the current-sinking/current-sourcing capability of the driver.

Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level.

The SN74ALVCH16500 is characterized for operation from -40°C to 85°C.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

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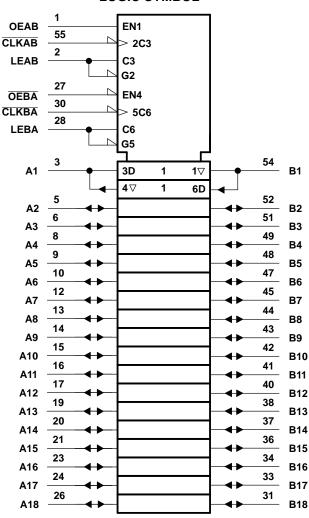
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FUNCTION TABLE(1)

	INP	UTS		OUTPUT
OEAB	LEAB	CLKAB	Α	В
L	Χ	Χ	Χ	Z
Н	Н	Χ	L	L
Н	Н	Χ	Н	Н
Н	L	\downarrow	L	L
Н	L	\downarrow	Н	Н
Н	L	Н	Χ	B ₀ ⁽²⁾
Н	L	L	Χ	B ₀ ⁽²⁾ B ₀ ⁽³⁾

- A-to-B data flow is shown; B-to-A flow is similar but uses OEBA, LEBA, and CLKBA.
- (2) Output level before the indicated steady-state input conditions were established, provided that CLKAB was high before LEAB went low
- (3) Output level before the indicated steady-state input conditions were established

LOGIC SYMBOL(1)



(1) This symbol is in accordance with ANSI/EEEE Std 91-1984 and IEC Publication 617-12.



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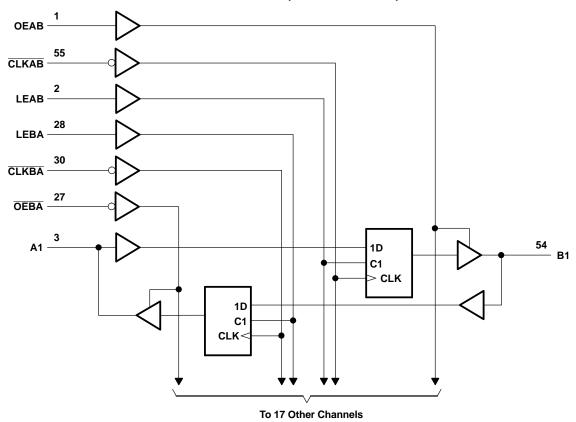
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LOGIC DIAGRAM (POSITIVE LOGIC)





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ABSOLUTE MAXIMUM RATINGS(1)

over operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT
V_{CC}	Supply voltage range		-0.5	4.6	V
M	land the same and an	Except I/O ports ⁽²⁾	-0.5	4.6	\ /
VI	Input voltage range	I/O ports ⁽²⁾⁽³⁾	-0.5 V _{CC}		V
Vo	Output voltage range ⁽²⁾⁽³⁾		-0.5	V _{CC} + 0.5	V
I _{IK}	Input clamp current	V ₁ < 0		-50	mA
I _{OK}	Output clamp current	V _O < 0		-50	mA
Io	Continuous output current			±50	mA
	Continuous current through each V _{CC} or	GND		±100	mA
0	Deales as the armed improduces (4)	DGG package		64	°C/W
θ_{JA}	Package thermal impedance (4)	DL package		56	-0/00
T _{stg}	Storage temperature range		-65	150	°C

⁽¹⁾ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

RECOMMENDED OPERATING CONDITIONS(1)

			MIN	MAX	UNIT
V _{CC}	Supply voltage		1.65	3.6	٧
		V _{CC} = 1.65 V to 1.95 V	$0.65 \times V_{CC}$		
V_{IH}	High-level input voltage	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.7		V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	2		
		V _{CC} = 1.65 V to 1.95 V		$0.35 \times V_{CC}$	
V_{IL}	Low-level input voltage	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		0.7	V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$		0.8	
V _I	Input voltage		0	V _{CC}	V
Vo	Output voltage		0	V _{CC}	V
		V _{CC} = 1.65 V		-4	
	High-level input voltage $V_{CC} = 1.65 \text{ V to}$ $V_{CC} = 2.3 \text{ V to } 2$ $V_{CC} = 2.7 \text{ V to } 3$ $V_{CC} = 1.65 \text{ V to}$ $V_{CC} = 1.65 \text{ V to}$ $V_{CC} = 2.3 \text{ V to } 2$ $V_{CC} = 2.7 \text{ V to } 3$ Input voltage Output voltage $V_{CC} = 2.7 \text{ V to } 3$ $V_{CC} = 2.7 \text{ V to } 3$ $V_{CC} = 2.3 \text{ V to } 3$ $V_{CC} = 2.7 \text{ V to } 3$ $V_{CC} = 2.7 \text{ V to } 3$ $V_{CC} = 2.7 \text{ V to } 3$ $V_{CC} = 2.3 \text{ V to } 3$ $V_{CC} = 2.3 \text{ V to } 3$ $V_{CC} = 2.3 \text{ V to } 3$	V _{CC} = 2.3 V		-12	mA
I _{OH}		$V_{CC} = 2.7 \text{ V}$		-12	IIIA
		V _{CC} = 3 V	0.65 × V _{CC} 1.7 2	-24	
		V _{CC} = 1.65 V		4	
	Low lovel output ourrent	V _{CC} = 2.3 V		12	mA
I _{OL}	Low-level output current	V _{CC} = 2.7 V		12	mA
		V _{CC} = 3 V		24	
Δt/Δν	Input transition rise or fall rate			10	ns/V
T _A	Operating free-air temperature		-40	85	°C

All unused control inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

⁽²⁾ The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.

³⁾ This value is limited to 4.6 V maximum.

⁽⁴⁾ The package thermal impedance is calculated in accordance with JESD 51.



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ELECTRICAL CHARACTERISTICS

over recommended operating free-air temperature range (unless otherwise noted)

PA	RAMETER	TEST CONDITIONS	V _{cc}	MIN TYP ⁽¹⁾	MAX	UNIT
		I _{OH} = -100 μA	1.65 V to 3.6 V	V _{CC} - 0.2		
		I _{OH} = -4 mA	1.65 V	1.2		
		I _{OH} = -6 mA	2.3 V	2		
V_{OH}			2.3 V	1.7		V
		I _{OH} = -12 mA	2.7 V	2.2		
			3 V	2.4		
		I _{OH} = -24 mA	3 V	2		
		$I_{OL} = 100 \mu A$	1.65 V to 3.6 V		0.2	
		I _{OL} = 4 mA	1.65 V		0.45	
\ /		$I_{OL} = 6 \text{ mA}$	2.3 V		0.4	
V_{OL}		1 40 1	2.3 V		0.7	V
		$I_{OL} = 12 \text{ mA}$	2.7 V		0.4	
		I _{OL} = 24 mA	3 V		0.55	
I _I		$V_I = V_{CC}$ or GND	3.6 V		±5	μΑ
		V _I = 0.58 V	1.65 V	25		
		V _I = 1.07 V	1.65 V	-25		
		V _I = 0.7 V	2.3 V	45		
I _{I(hold)}		V _I = 1.7 V	2.3 V	-45		μΑ
		V _I = 0.8 V	3 V	75		
		V _I = 2 V	3 V	-75		
		$V_1 = 0 \text{ to } 3.6 \text{ V}^{(2)}$	3.6 V		±500	
I _{OZ} (3)		$V_O = V_{CC}$ or GND	3.6 V		±10	μΑ
I_{CC}		$V_I = V_{CC}$ or GND, $I_O = 0$	3.6 V		40	μΑ
ΔI_{CC}		One input at V _{CC} - 0.6 V, Other inputs at V _{CC} or GND	3 V to 3.6 V		750	μΑ
Ci	Control inputs	$V_I = V_{CC}$ or GND	3.3 V	4		pF
C_{io}	A or B ports	$V_O = V_{CC}$ or GND	3.3 V	8		pF

All typical values are at $V_{CC} = 3.3 \text{ V}$, $T_A = 25^{\circ}\text{C}$. This is the bus-hold maximum dynamic current. It is the minimum overdrive current required to switch the input from one state to

For I/O ports, the parameter I_{OZ} includes the input leakage current.



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TIMING REQUIREMENTS

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1 through Figure 3)

				V _{CC} = 1.8 V		V _{CC} = 2.5 V ± 0.2 V		V _{CC} = 2.7 V		V_{CC} = 3.3 V \pm 0.3 V		UNIT
				MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
f _{clock}	Clock frequency				(1)		150		150		150	MHz
t _w Pulse duration	LE high				3.3		3.3		3.3		2	
	CLK high or low				3.3		3.3		3.3		ns	
		Data before CLK ↓				1.7		1.4		1.3		
t _{su}	Setup time	Data before LE↓	CLK high	(1)		1.1		1		1		ns
		Data before LEV	CLK low	(1)		1.9		1.6		1.4		
		Data after CLK↓				1.7		1.6		1.3		
t _h Hold time	Data after LE↓	CLK high	(1)		2		1.8		1.5		ns	
		Data after LE↓	CLK low	(1)		1.6		1.5		1.2		

⁽¹⁾ This information was not available at the time of publication.

SWITCHING CHARACTERISTICS

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1 through Figure 3)

PARAMETER	FROM	TO (OUTPUT)	V _{CC} = 1.8 V		V_{CC} = 2.5 V \pm 0.2 V		V _{CC} =	2.7 V	V _{CC} = 3 ± 0.3	3.3 V 3 V	UNIT
	(INPUT)	(OUTPUT)	MIN	TYP	MIN	MAX	MIN	MAX	MIN	MAX	
f _{max}			(1)		150		150		150		MHz
	A or B	B or A		(1)	1	5.1		4.7	1	3.9	
t _{pd}	LEAB or LEBA	A or B		(1)	1	5.9		5.5	1	4.7	ns
	CLKAB or CLKBA	AOIB		(1)	1	6.6		6.6	1.1	5.5	
t _{en}	OEAB	В		(1)	1	5.7		5.4	1	4.6	ns
t _{dis}	OEAB	В		(1)	1	6.1		5.7	1.5	5	ns
t _{en}	OEBA	А		(1)	1	6.2		6.2	1	5.2	ns
t _{dis}	OEBA	А		(1)	1	5.4		4.6	1	4.3	ns

⁽¹⁾ This information was not available at the time of publication.

OPERATING CHARACTERISTICS

 $T_A = 25^{\circ}C$

	PARAMETE	R	TEST CONDITIONS	V _{CC} = 1.8 V TYP	V _{CC} = 2.5 V TYP	V _{CC} = 3.3 V TYP	UNIT	
_	Power dissipation	Outputs enabled	C _ 50 pE f _ 10 MHz	(1)	40	51		
Cpd	capacitance	Outputs disabled	$C_L = 50 \text{ pF, f} = 10 \text{ MHz}$	(1)	6	6	pF	

⁽¹⁾ This information was not available at the time of publication.

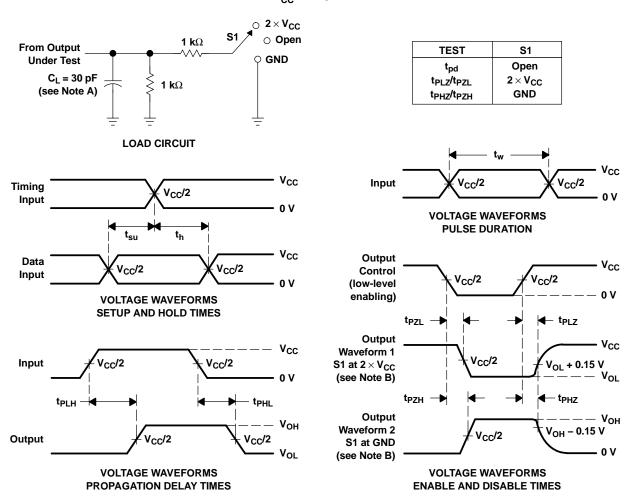
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PARAMETER MEASUREMENT INFORMATION $V_{CC} = 1.8 \text{ V}$



NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_O = 50 Ω , $t_f \leq$ 2 ns. $t_f \leq$ 2 ns.
- D. The outputs are measured one at a time, with one transition per measurement.
- E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
- F. t_{PZL} and t_{PZH} are the same as t_{en}.
- G. t_{PLH} and t_{PHL} are the same as t_{pd}.

Figure 1. Load Circuit and Voltage Waveforms



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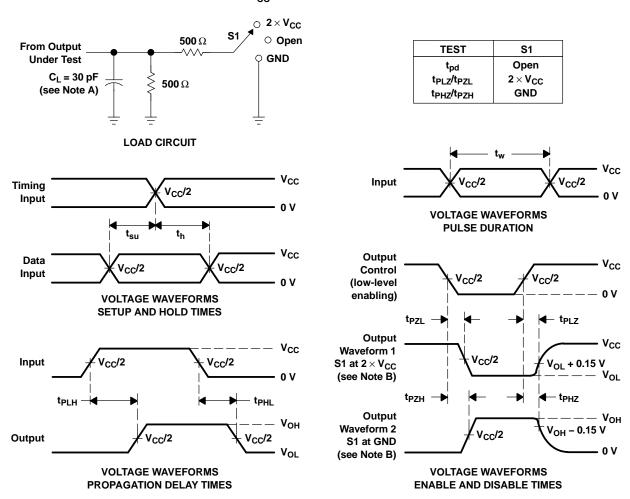
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PARAMETER MEASUREMENT INFORMATION V_{cc} = 2.5 V \pm 0.2 V



NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50 \Omega$, $t_r \leq 2$ ns. $t_f \leq 2$ ns.
- D. The outputs are measured one at a time, with one transition per measurement.
- E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
- F. t_{PZL} and t_{PZH} are the same as t_{en}.
- G. t_{PLH} and t_{PHL} are the same as t_{pd}.

Figure 2. Load Circuit and Voltage Waveforms

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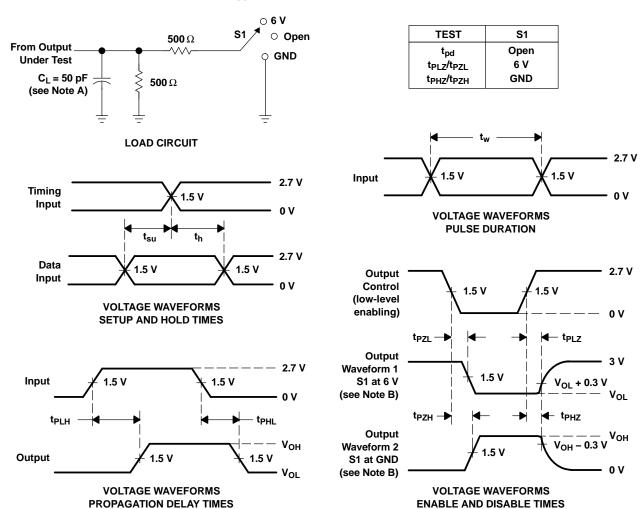
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PARAMETER MEASUREMENT INFORMATION $V_{CC} = 2.7 \text{ V AND } 3.3 \text{ V} \pm 0.3 \text{ V}$



NOTES: A. C_I includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50~\Omega$, $t_f \leq$ 2.5 ns. $t_f \leq$ 2.5 ns.
- D. The outputs are measured one at a time, with one transition per measurement.
- E. t_{PLZ} and t_{PHZ} are the same as t_{dis}.
- F. t_{PZL} and t_{PZH} are the same as t_{en}.
- G. t_{PLH} and t_{PHL} are the same as t_{pd}.

Figure 3. Load Circuit and Voltage Waveforms



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PACKAGE OPTION ADDENDUM

27-Sep-2007

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
74ALVCH16500DGGRE4	ACTIVE	TSSOP	DGG	56	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
74ALVCH16500DGGRG4	ACTIVE	TSSOP	DGG	56	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
74ALVCH16500DLG4	ACTIVE	SSOP	DL	56	20	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
74ALVCH16500DLRG4	ACTIVE	SSOP	DL	56	1000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALVCH16500DGGR	ACTIVE	TSSOP	DGG	56	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALVCH16500DL	ACTIVE	SSOP	DL	56	20	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALVCH16500DLR	ACTIVE	SSOP	DL	56	1000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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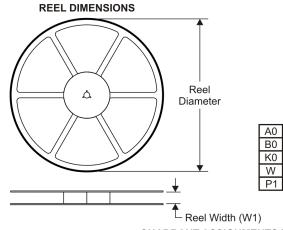
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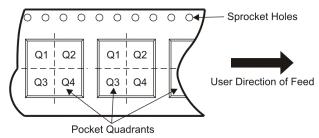
TAPE AND REEL INFORMATION



TAPE DIMENSIONS + K0 + P1 + B0 W Cavity - A0 +

	Dimension designed to accommodate the component width
	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing			Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74ALVCH16500DGGR	TSSOP	DGG	56	2000	330.0	24.4	8.6	15.6	1.8	12.0	24.0	Q1
SN74ALVCH16500DLR	SSOP	DL	56	1000	330.0	32.4	11.35	18.67	3.1	16.0	32.0	Q1

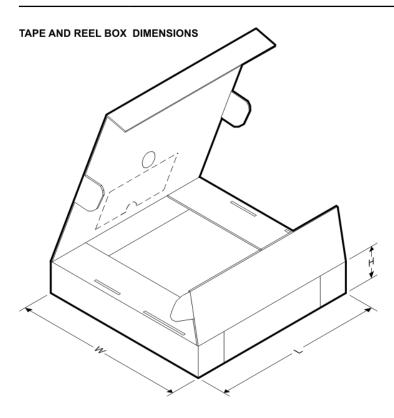
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Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74ALVCH16500DGGR	TSSOP	DGG	56	2000	346.0	346.0	41.0
SN74ALVCH16500DLR	SSOP	DL	56	1000	346.0	346.0	49.0



Datasheet of SN74ALVCH16500DGGR - IC UNIV BUS TXRX 18BIT 56TSSOP Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

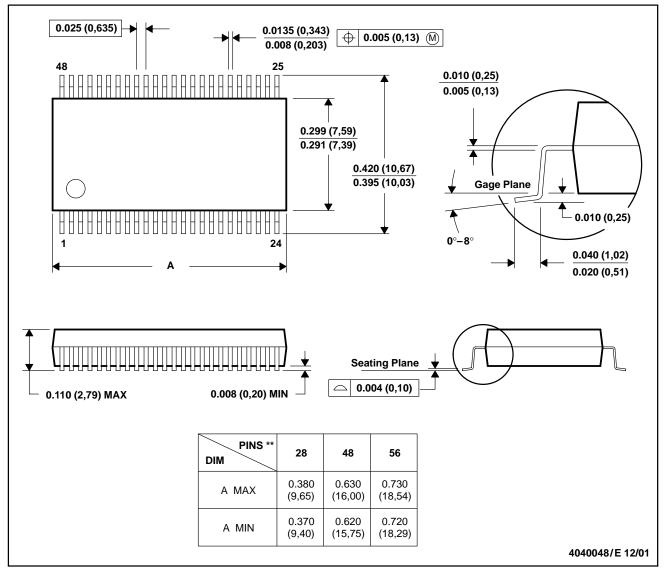
MECHANICAL DATA

MSSO001C - JANUARY 1995 - REVISED DECEMBER 2001

DL (R-PDSO-G**)

48 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

D. Falls within JEDEC MO-118





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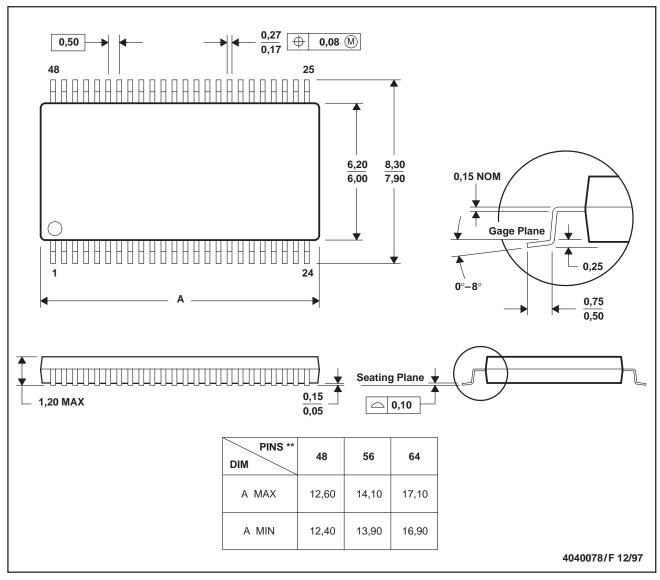
MECHANICAL DATA

MTSS003D - JANUARY 1995 - REVISED JANUARY 1998

DGG (R-PDSO-G**)

48 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-153





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